

**FEATURES**

- Double Side Cooling
- High Surge Capability

**APPLICATIONS**

- High Power Drives
- High Voltage Power Supplies
- Static Switches

**VOLTAGE RATINGS**

Part and Ordering Number	Repetitive Peak Voltages $V_{DRM}$ and $V_{RRM}$ V	Conditions
DCR2560A85*	8500	$T_{vj} = -40^{\circ}\text{C}$ to $125^{\circ}\text{C}$ , $I_{DRM} = I_{RRM} = 300\text{mA}$ , $V_{DRM}, V_{RRM} t_p = 10\text{ms}$ , $V_{DSM} \& V_{RSM} =$ $V_{DRM} \& V_{RRM} + 100\text{V}$ respectively
DCR2560A80	8000	
DCR2560A75	7500	
DCR2560A70	7000	

Lower voltage grades available.  
 \*8200V @  $-40^{\circ}\text{C}$ , 8500V @  $0^{\circ}\text{C}$

**ORDERING INFORMATION**

When ordering, select the required part number shown in the Voltage Ratings selection table.

For example:

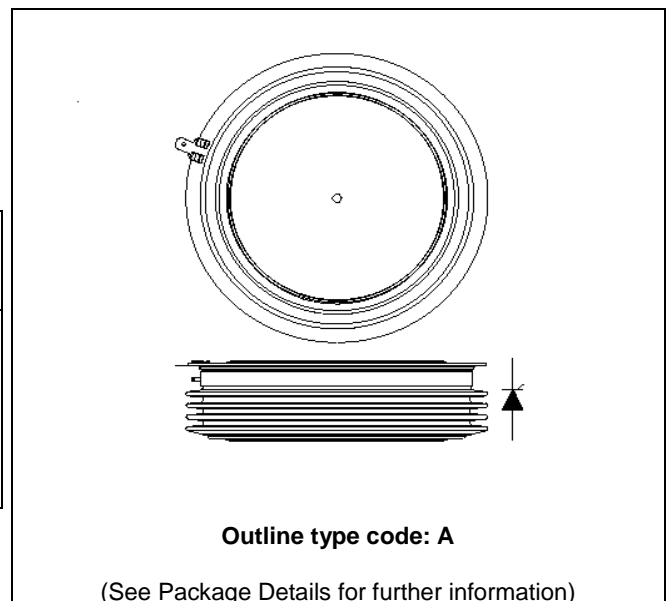
**DCR2560A85**

Note: Please use the complete part number when ordering and quote this number in any future correspondence relating to your order.

**KEY PARAMETERS**

$V_{DRM}$	<b>8500V</b>
$I_{T(AV)}$	<b>2560A</b>
$I_{TSM}$	<b>32500A</b>
$dV/dt^*$	<b>1500V/<math>\mu\text{s}</math></b>
$di/dt$	<b>200A/<math>\mu\text{s}</math></b>

\* Higher  $dV/dt$  selections available



**Fig. 1 Package outline**

## CURRENT RATINGS

$T_{case} = 60^{\circ}\text{C}$  unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units
<b>Double Side Cooled</b>				
$I_{T(AV)}$	Mean on-state current	Half wave resistive load	2555	A
$I_{T(RMS)}$	RMS value	-	4013	A
$I_T$	Continuous (direct) on-state current	-	3710	A

## SURGE RATINGS

Symbol	Parameter	Test Conditions	Max.	Units
$I_{TSM}$	Surge (non-repetitive) on-state current	10ms half sine, $T_{case} = 125^{\circ}\text{C}$	32.5	kA
$I^2t$	$I^2t$ for fusing	$V_R = 0$	5.28	$\text{MA}^2\text{s}$

## THERMAL AND MECHANICAL RATINGS

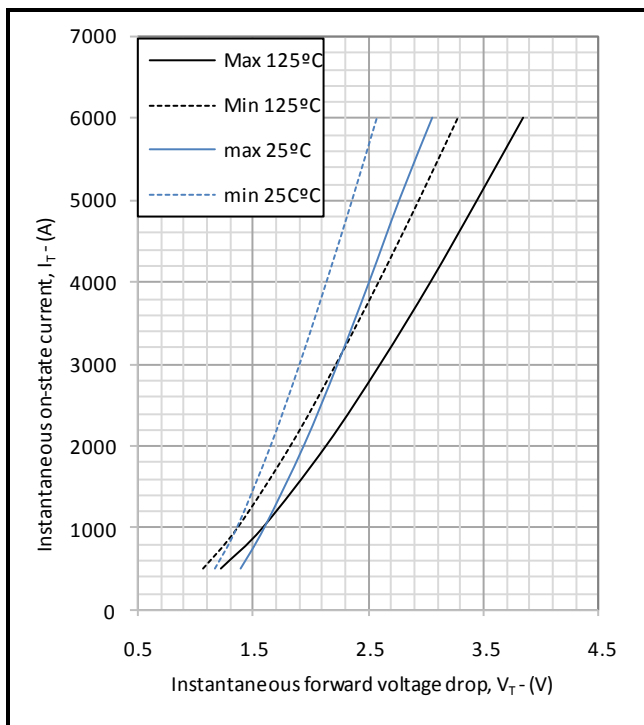
Symbol	Parameter	Test Conditions	Min.	Max.	Units	
$R_{th(j-c)}$	Thermal resistance – junction to case	Double side cooled	DC	-	0.00603	$^{\circ}\text{C/W}$
		Single side cooled	Anode DC	-	0.01024	$^{\circ}\text{C/W}$
			Cathode DC	-	0.01467	$^{\circ}\text{C/W}$
$R_{th(c-h)}$	Thermal resistance – case to heatsink	Clamping force 83.0kN (with mounting compound)	Double side	-	0.001	$^{\circ}\text{C/W}$
			Single side	-	0.002	$^{\circ}\text{C/W}$
$T_{vj}$	Virtual junction temperature	Blocking $V_{DRM} / V_{RRM}$	-	125	$^{\circ}\text{C}$	
$T_{stg}$	Storage temperature range		-55	125	$^{\circ}\text{C}$	
$F_m$	Clamping force		74.0	91.0	kN	

**DYNAMIC CHARACTERISTICS**

Symbol	Parameter	Test Conditions	Min.	Max.	Units
$I_{RRM}/I_{DRM}$	Peak reverse and off-state current	At $V_{RRM}/V_{DRM}$ , $T_{case} = 125^{\circ}C$	-	300	mA
$dV/dt$	Max. linear rate of rise of off-state voltage	To 67% $V_{DRM}$ , $T_j = 125^{\circ}C$ , gate open	-	1500	V/ $\mu s$
$dl/dt$	Rate of rise of on-state current	From 67% $V_{DRM}$ to $2x I_{T(AV)}$ Repetitive 50Hz	-	100	A/ $\mu s$
		Gate source 30V, 10 $\Omega$ , $t_r < 0.5\mu s$ , $T_j = 125^{\circ}C$ Non-repetitive	-	200	A/ $\mu s$
$V_{T(TO)}$	Threshold voltage – Low level	500 to 1600A at $T_{case} = 125^{\circ}C$	-	0.9	V
	Threshold voltage – High level	1600 to 4000A at $T_{case} = 125^{\circ}C$	-	1.18	V
$r_T$	On-state slope resistance – Low level	500A to 1600A at $T_{case} = 125^{\circ}C$	-	0.65	m $\Omega$
	On-state slope resistance – High level	1600A to 4000A at $T_{case} = 125^{\circ}C$	-	0.46	m $\Omega$
$t_{gd}$	Delay time	$V_D = 67\% V_{DRM}$ , gate source 30V, 10 $\Omega$ $t_r = 0.5\mu s$ , $T_j = 25^{\circ}C$	-	3	$\mu s$
$t_q$	Turn-off time	$I_T = 3000A$ , $T_j = 125^{\circ}C$ , $V_R = 200V$ , $dl/dt = 1A/\mu s$ , $dV_{DR}/dt = 20V/\mu s$ linear		1000	$\mu s$
$Q_S$	Stored charge	$I_T = 3000A$ , $T_j = 125^{\circ}C$ , $dl/dt = 1A/\mu s$ , $V_{Rpeak} \sim 5100V$ , $V_R \sim 3400V$	5150	7950	$\mu C$
$I_L$	Latching current	$T_j = 25^{\circ}C$ , $V_D = 5V$	-	3	A
$I_H$	Holding current	$T_j = 25^{\circ}C$ , $R_{G-K} = \infty$ , $I_{TM} = 500A$ , $I_T = 5A$	-	300	mA

**GATE TRIGGER CHARACTERISTICS AND RATINGS**

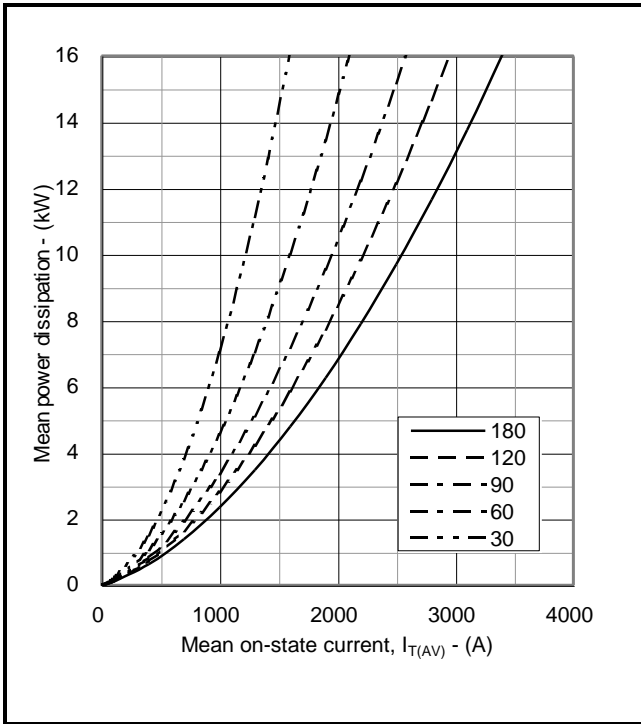
Symbol	Parameter	Test Conditions	Max.	Units
V <sub>GT</sub>	Gate trigger voltage	V <sub>DRM</sub> = 5V, T <sub>case</sub> = 25°C	1.5	V
V <sub>GD</sub>	Gate non-trigger voltage	At 50% V <sub>DRM</sub> , T <sub>case</sub> = 125°C	0.4	V
I <sub>GT</sub>	Gate trigger current	V <sub>DRM</sub> = 5V, T <sub>case</sub> = 25°C	400	mA
I <sub>GD</sub>	Gate non-trigger current	At 50% V <sub>DRM</sub> , T <sub>case</sub> = 125°C	10	mA

**CURVES**

**Fig.2 Maximum & minimum on-state characteristics**
**V<sub>TM</sub> EQUATION**

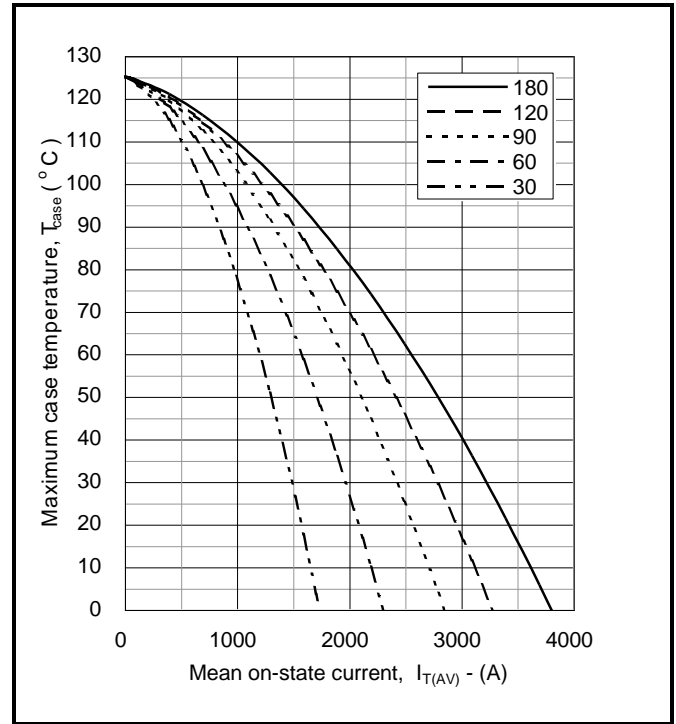
$$V_{TM} = A + B \ln(I_T) + C \cdot I_T + D \cdot \sqrt{I_T}$$

Where A = -0.224010  
 B = 0.1725829  
 C = 0.000292  
 D = 0.01039

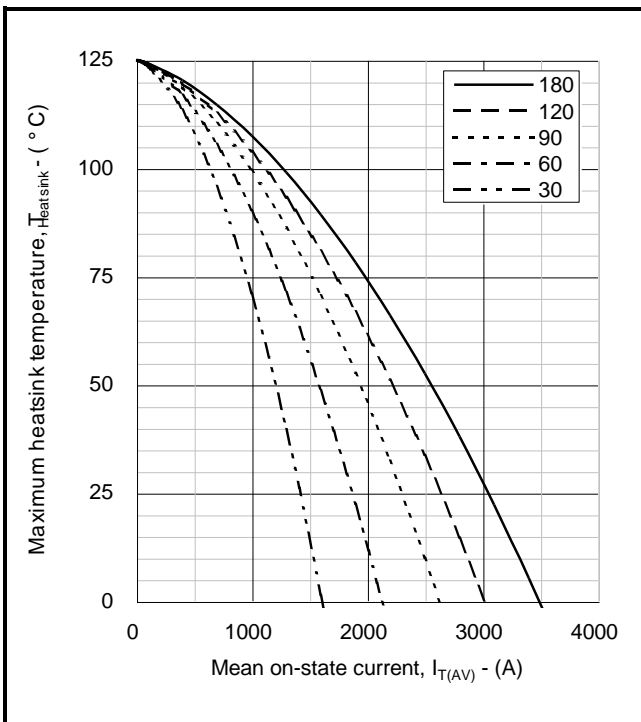
these values are valid for T<sub>j</sub> = 125°C for I<sub>T</sub> 500A to 4200A



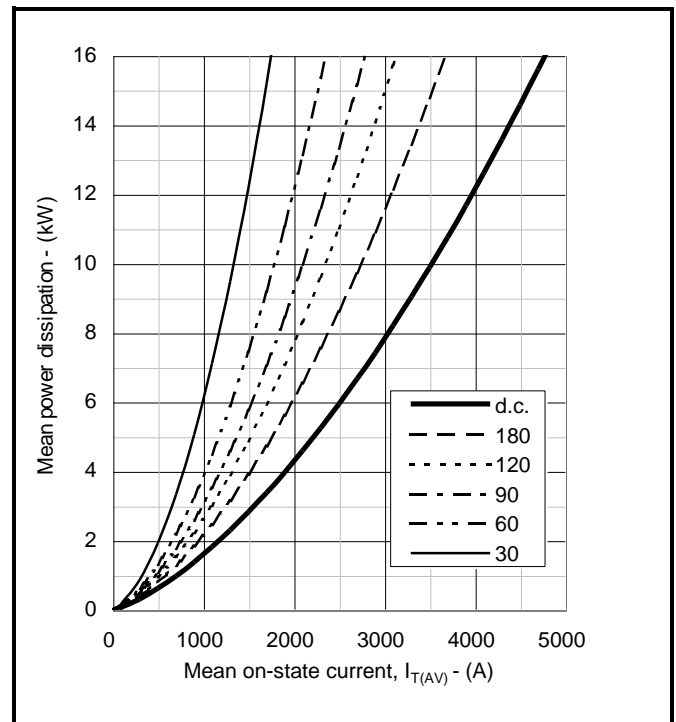
**Fig.3 On-state power dissipation – sine wave**



**Fig.4 Maximum permissible case temperature, double side cooled – sine wave**



**Fig.5 Maximum permissible heatsink temperature, double side cooled – sine wave**



**Fig.6 On-state power dissipation – rectangular wave**

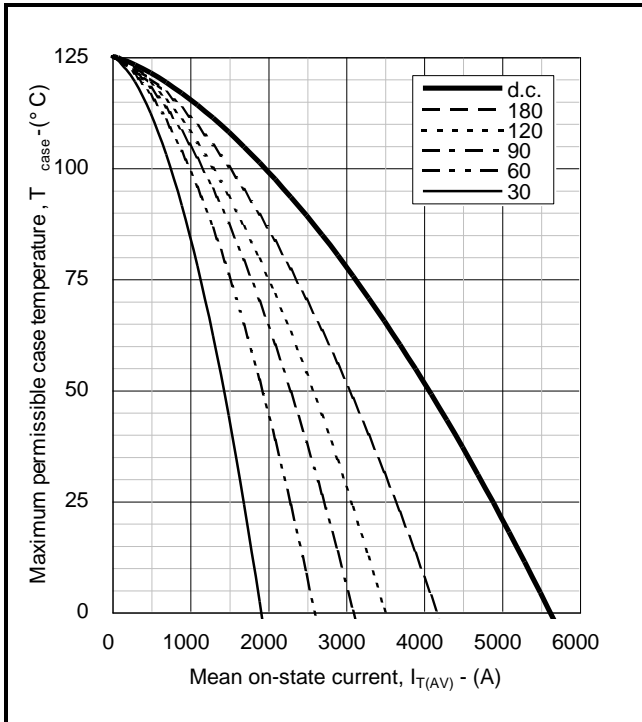


Fig.7 Maximum permissible case temperature, double side cooled – rectangular wave

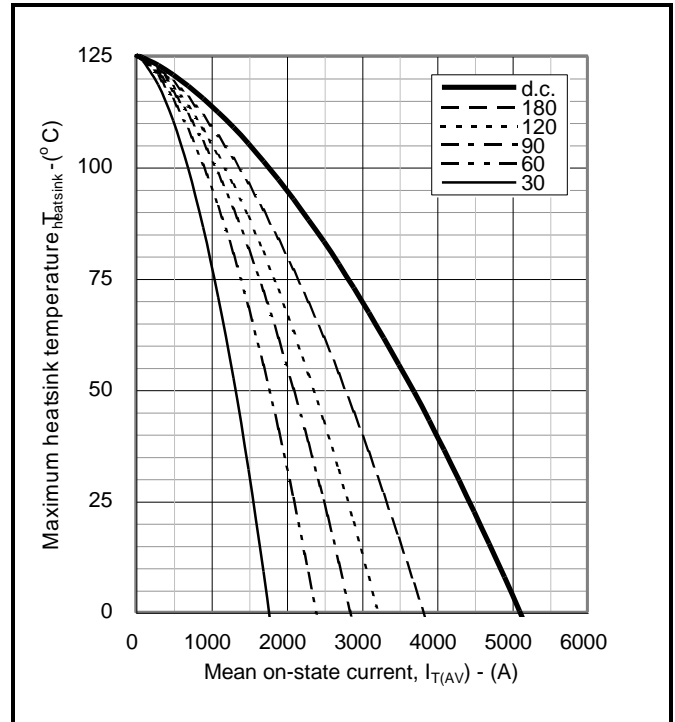


Fig.8 Maximum permissible heatsink temperature, double side cooled – rectangular wave

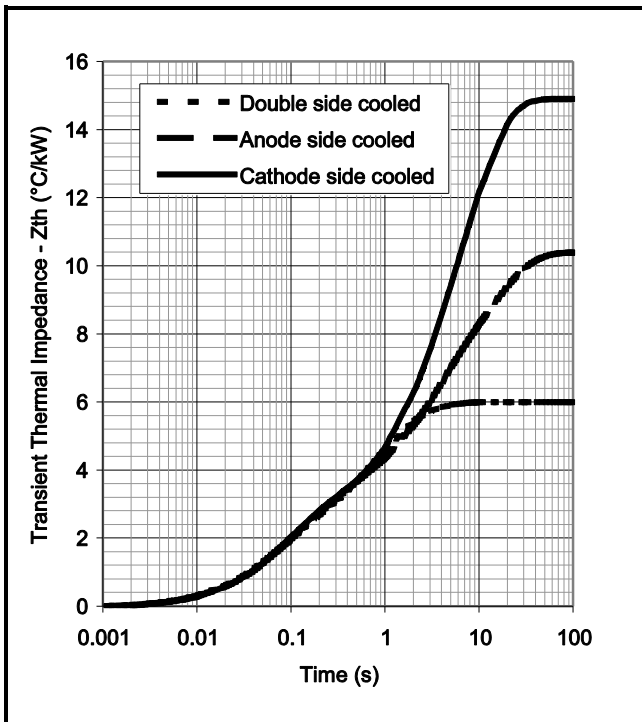


Fig.9 Maximum (limit) transient thermal impedance – junction to case (°C/kW)

		1	2	3	4
Double side cooled	R <sub>i</sub> (°C/kW)	3.01541	1.048955	0.983519	0.983519
	T <sub>i</sub> (s)	0.703874	1.904794	0.059	0.059
Anode side cooled	R <sub>i</sub> (°C/kW)	3.156003	4.092806	1.556555	1.623962
	T <sub>i</sub> (s)	2.69023	13.79162	0.059	0.205916
Cathode side cooled	R <sub>i</sub> (°C/kW)	7.077369	3.483481	1.745839	2.634274
	T <sub>i</sub> (s)	6.648601	8.436484	1.762119	0.08069

$$Z_{th} = \sum_{i=1}^{i=4} [R_i \times (1 - \exp(-T/T_i))]$$

**ΔR<sub>th(j-c)</sub> Conduction**

Tables show the increments of thermal resistance R<sub>th(j-c)</sub> when the device operates at conduction angles other than d.c.

Double side cooling		
θ°	ΔZ <sub>th</sub> (z)	
	sine.	rect.
180	0.44	0.31
120	0.49	0.43
90	0.55	0.49
60	0.60	0.55
30	0.64	0.61
15	0.66	0.64

Anode Side Cooling		
θ°	ΔZ <sub>th</sub> (z)	
	sine.	rect.
180	0.42	0.30
120	0.47	0.41
90	0.52	0.46
60	0.57	0.52
30	0.61	0.58
15	0.62	0.61

Cathode Sided Cooling		
θ°	ΔZ <sub>th</sub> (z)	
	sine.	rect.
180	0.42	0.30
120	0.47	0.41
90	0.52	0.46
60	0.57	0.52
30	0.60	0.58
15	0.62	0.60

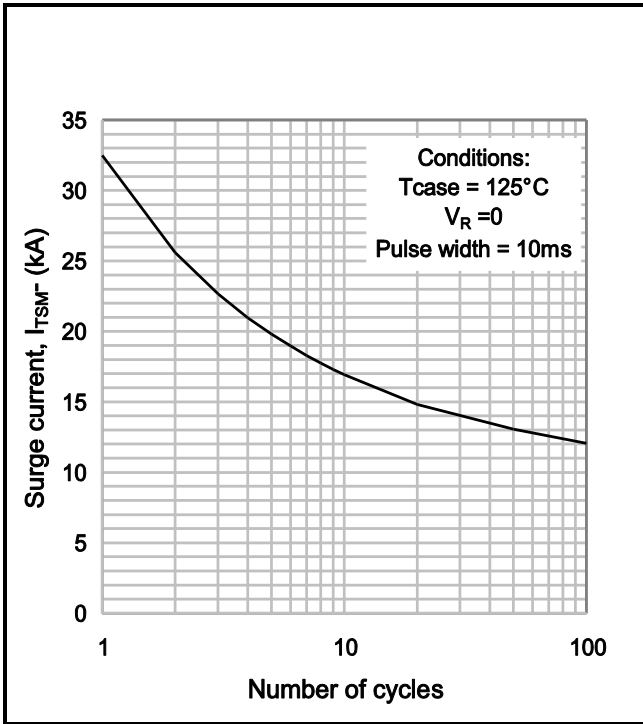


Fig.10 Multi-cycle surge current

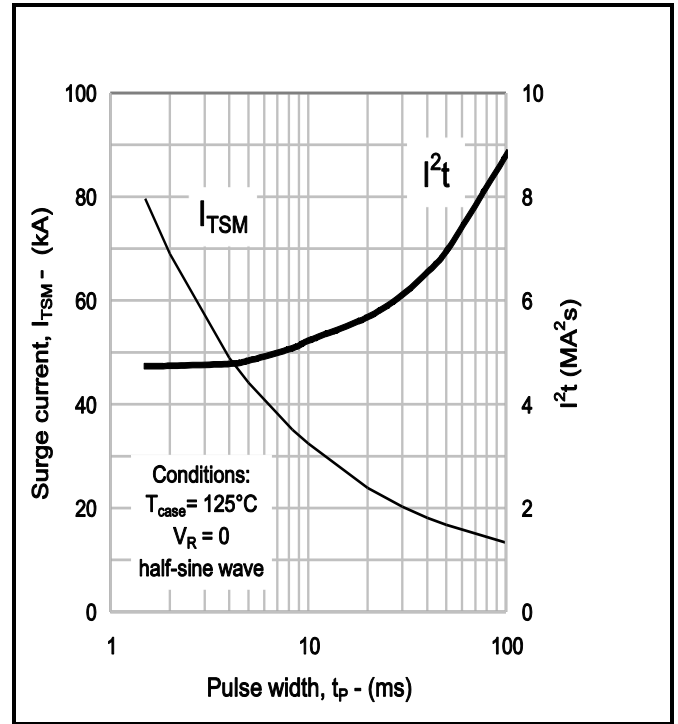


Fig.11 Single-cycle surge current

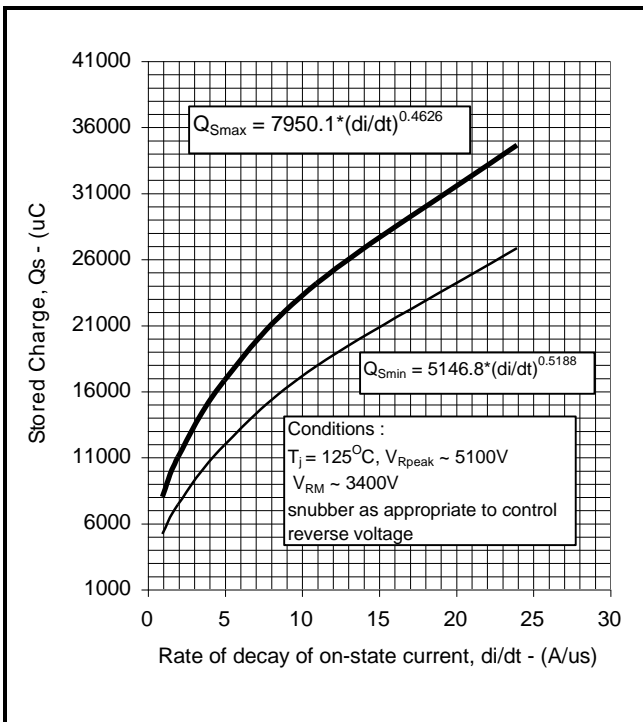


Fig.12 Stored charge

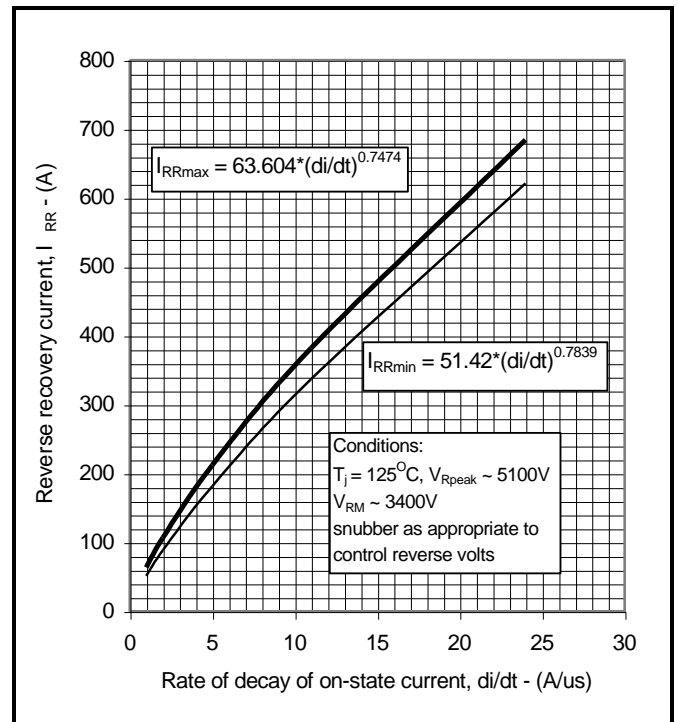
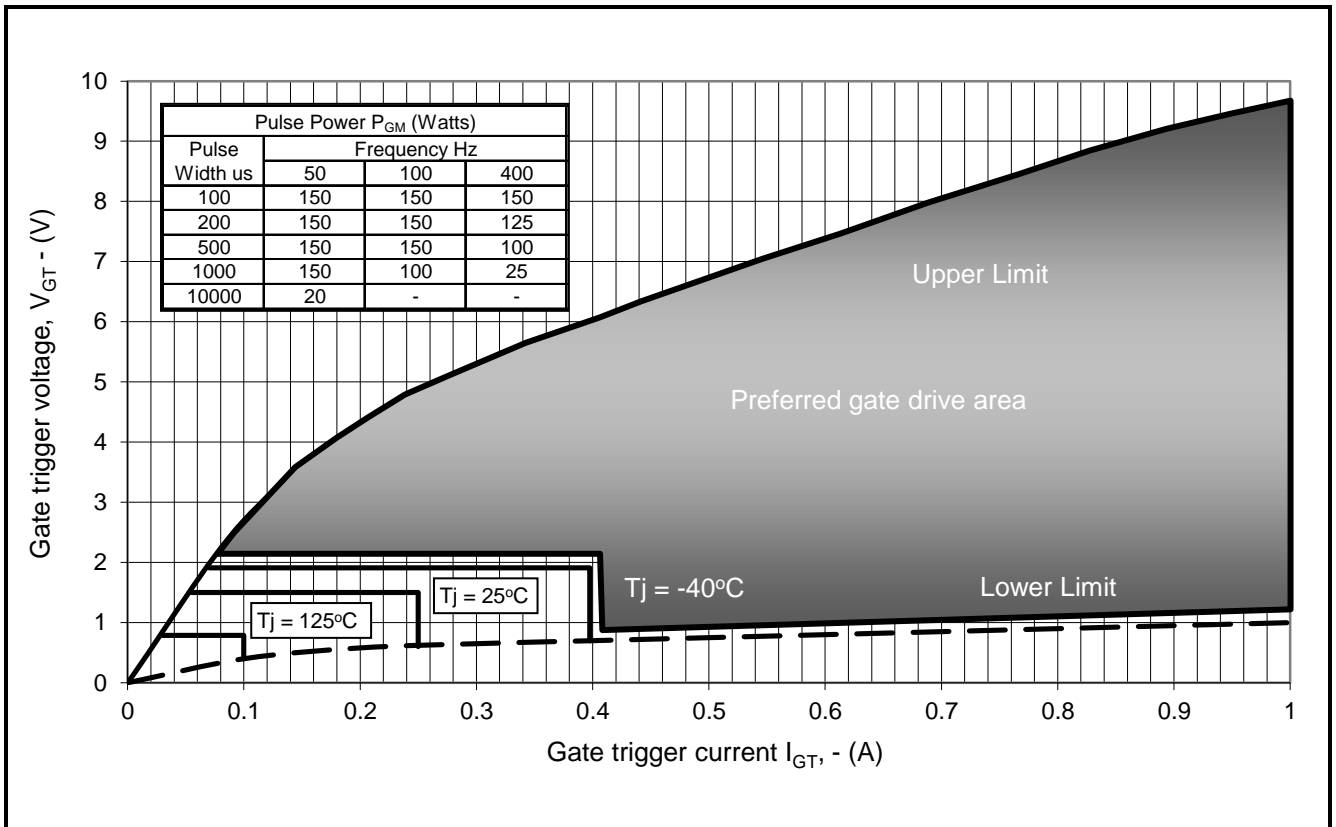
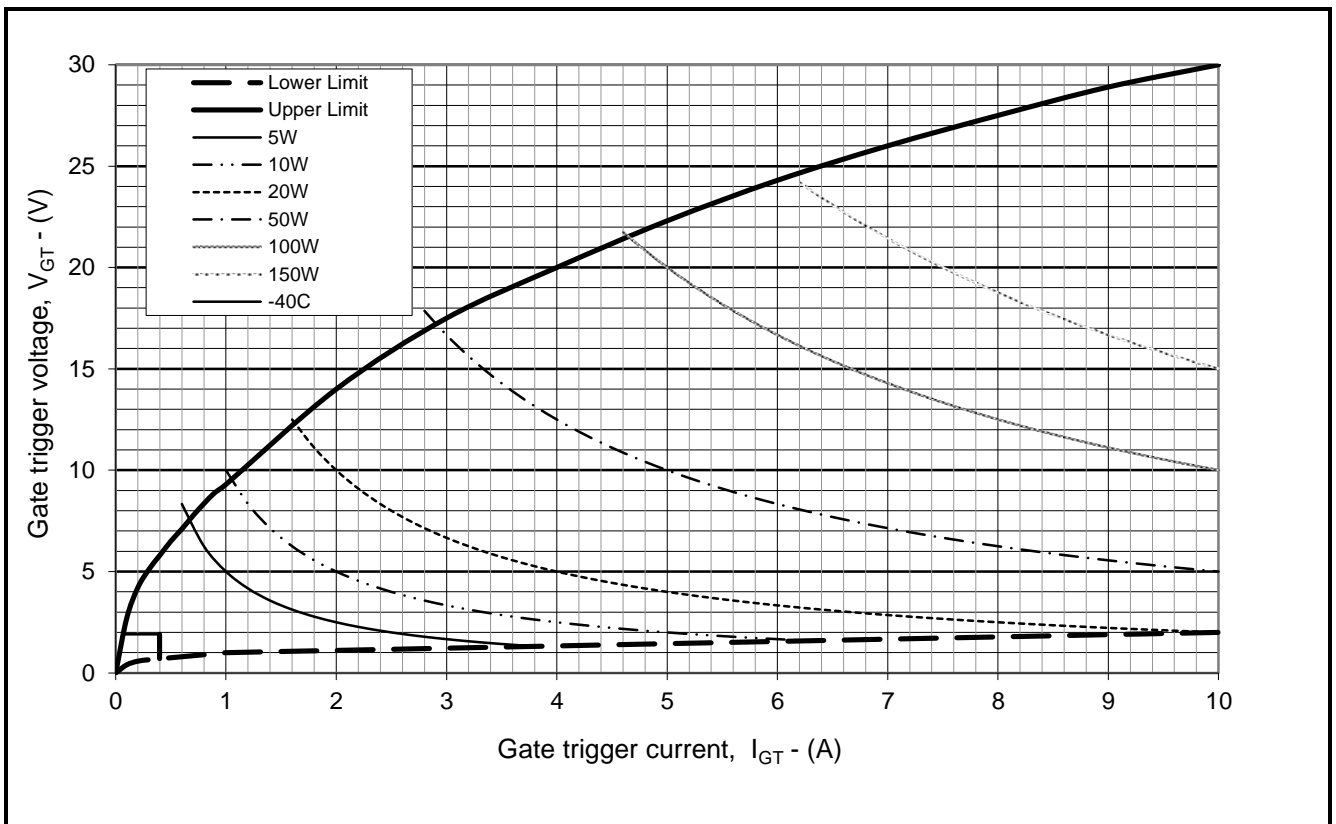


Fig.13 Reverse recovery current



**Fig14 Gate Characteristics**

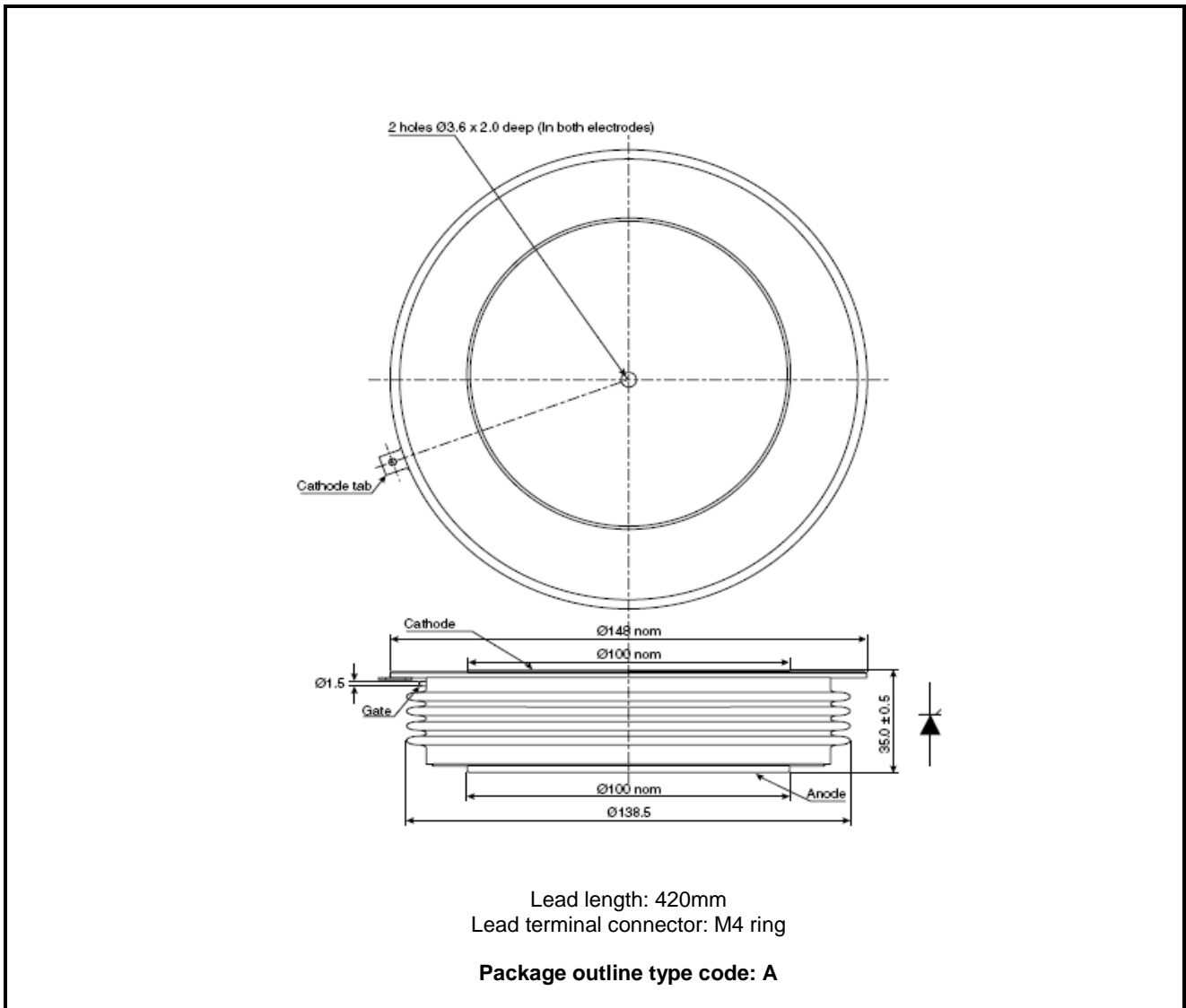


**Fig. 15 Gate characteristics**



**PACKAGE DETAILS**

For further package information, please contact Customer Services. All dimensions in mm, unless stated otherwise. DO NOT SCALE.



**Fig.16 Package outline**

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